



Product Change Notification / SYST-06KSXF150

Date:

07-Aug-2020

Product Category:

PoE PD

PCN Type:

Document Change

Notification Subject:

Data Sheet - PD70224 Datasheet

Affected CPNs:

[SYST-06KSXF150_Affected_CPN_08072020.pdf](#)
[SYST-06KSXF150_Affected_CPN_08072020.csv](#)

Notification Text:

SYST-06KSXF150

Microchip has released a new Product Documents for the PD70224 Datasheet of devices. If you are using one of these devices please read the document located at [PD70224 Datasheet](#).

Notification Status:

Final

Description of Change:

- 1) Updated to Microchip format.
- 2) Updated document number from PD-000306655 to DS00003575
- 3) Deleted figure "PD70224 Bottom layer Copper and Solder Paste Recommended PCB Layout for Thermal Pad Array (mm)" in Recommended PCB Layout
- 4) Updated package marking in Ordering Information

Impacts to Data Sheet:

None

Reason for Change: To Improve Manufacturability

Change Implementation Status: Complete

Date Document Changes Effective: 07 August 2020

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachments:

[PD70224 Datasheet](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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